

# NCV8518A

## Low Dropout Linear Regulator with Watchdog, Wake Up, RESET, and ENABLE

The NCV8518A device is a precision micropower voltage regulator. It has a fixed output voltage of 5.0 V and regulates within  $\pm 2\%$ . It is suitable for use in all automotive environments and contains all the required functions to control a microprocessor. This device has low dropout voltage and low quiescent current. It includes a watchdog timer, adjustable reset, wake up and enable function. Also encompassed in this device are safety features such as thermal shutdown and short circuit protection. It is capable of handling up to 45 V transients.

### Features

- Output Voltage of 5.0 V
- $\pm 2\%$  Output Voltage Tolerance
- Output Current up to 250 mA
- Micropower Compatible Control Functions:
  - ENABLE
  - Watchdog
  - RESET
  - Wake Up
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control
- Low Dropout Voltage
- Low Quiescent Current of 100  $\mu\text{A}$
- Protection Features:
  - Thermal Shutdown
  - Short Circuit
- Low Sleep Mode Current less than 1.0  $\mu\text{A}$
- AEC Qualified
- PPAP Capable
- These are Pb-Free Devices

### Applications

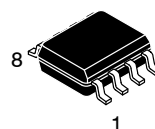
- Tire Pressure Monitor
- Battery Powered Consumer Electronics



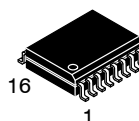
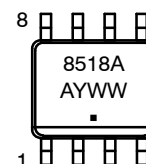
ON Semiconductor®

<http://onsemi.com>

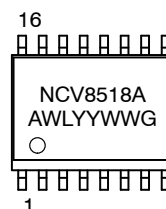
### MARKING DIAGRAMS



SOIC-8  
EXPOSED PAD  
CASE 751AC



SOIC-16 LEAD  
WIDE BODY  
EXPOSED PAD  
CASE 751AG



A = Assembly Location  
WL = Wafer Lot  
YY, Y = Year  
WW = Work Week  
▪, or G = Pb-Free Package

### ORDERING INFORMATION

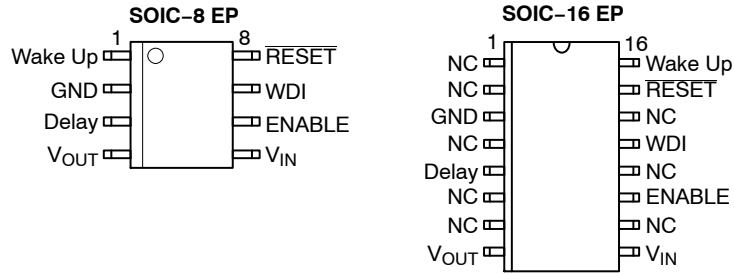
| Device        | Package  | Shipping <sup>†</sup> |
|---------------|----------|-----------------------|
| NCV8518APDG   | SOIC-8*  | 98 Units / Rail       |
| NCV8518APDR2G | SOIC-8*  | 2500 / Tape & Reel    |
| NCV8518APWG   | SOIC-16* | 47 Units / Rail       |
| NCV8518APWR2G | SOIC-16* | 1000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*These packages are inherently Pb-Free.

# NCV8518A

## PIN CONNECTIONS



## PIN FUNCTION DESCRIPTION

| Pin       |                           | Symbol           | Description                                                                                                                                                                                                                                             |
|-----------|---------------------------|------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SOIC-8 EP | SOIC-16 EP                |                  |                                                                                                                                                                                                                                                         |
| 4         | 8                         | V <sub>OUT</sub> | Regulated output voltage.                                                                                                                                                                                                                               |
| 5         | 9                         | V <sub>IN</sub>  | Input supply voltage.                                                                                                                                                                                                                                   |
| 7         | 13                        | WDI              | CMOS compatible Watchdog input. The watchdog function monitors the falling edge of the incoming signal.                                                                                                                                                 |
| 2         | 3                         | GND              | Ground connection.                                                                                                                                                                                                                                      |
| 6         | 11                        | ENABLE           | ENABLE control for the IC. Positive logic. If ENABLE control will not be used, connect this pin to V <sub>IN</sub> via a 20k current limiting resistor. Internal ESD protection structures will clamp the maximum ENABLE voltage to approximately 21 V. |
| 8         | 15                        | RESET            | CMOS compatible output RESET goes low whenever V <sub>OUT</sub> drops by more than 7.0% from nominal, or during the absence of a correct watchdog signal.                                                                                               |
| 3         | 5                         | Delay            | Buffered reference voltage used to create timing current for RESET and Watchdog threshold frequency from R <sub>Delay</sub> .                                                                                                                           |
| –         | 1, 2, 4, 6, 7, 10, 12, 14 | NC               | No Connection.                                                                                                                                                                                                                                          |
| 1         | 16                        | Wake Up          | Continuously generated signal that interrupts the microprocessor from sleep mode.                                                                                                                                                                       |
| EPAD      | EPAD                      | EPAD             | Connect to Ground potential or leave unconnected.                                                                                                                                                                                                       |

# NCV8518A

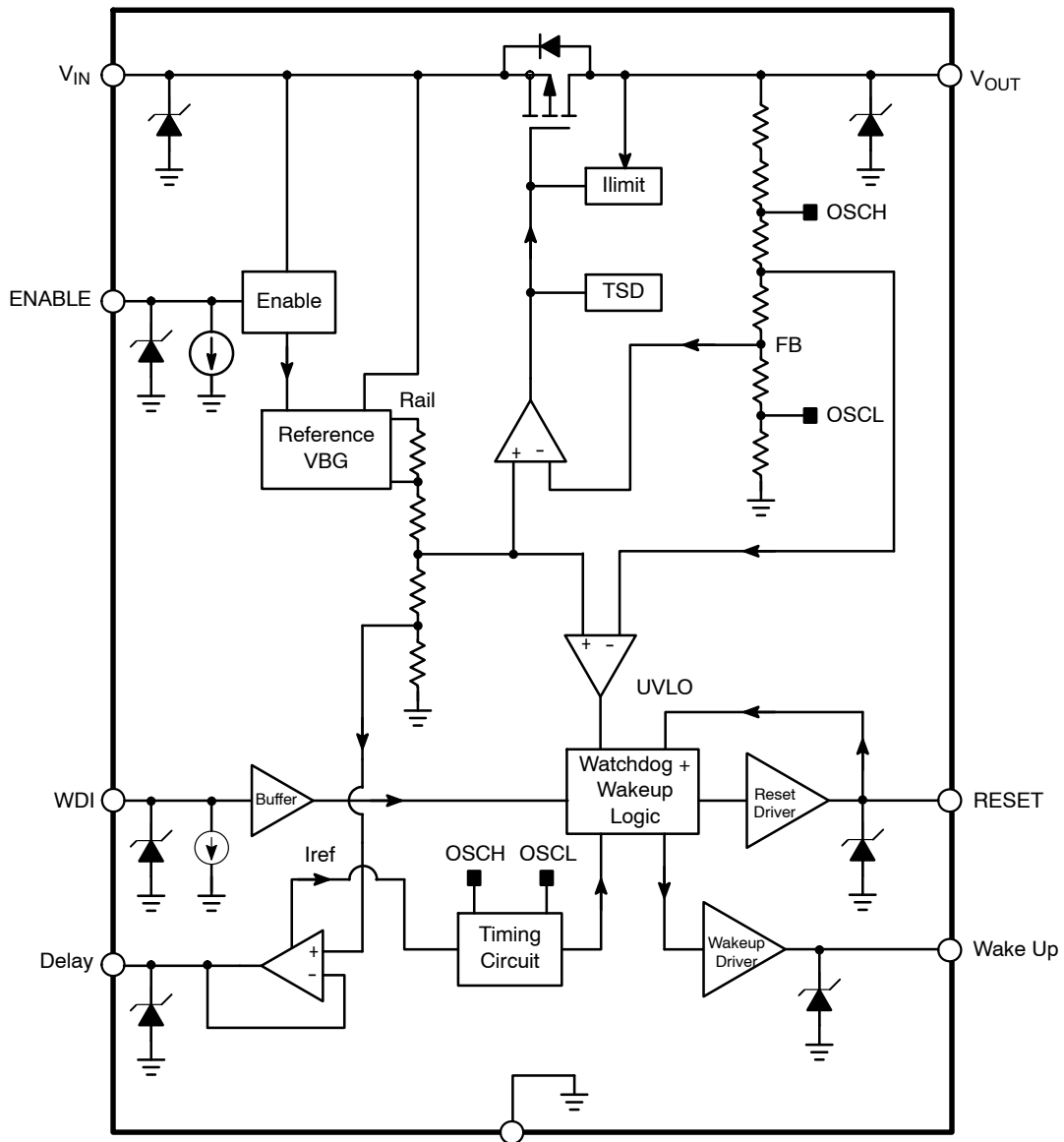


Figure 1. Block Diagram

## MAXIMUM RATINGS

| Rating                                                                                                                                                    | Symbol       | Value                | Unit     |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|----------------------|----------|
| Input Voltage                                                                                                                                             | $V_{IN}$     | -0.3 to 45           | V        |
| ENABLE Voltage<br>(ENABLE may be connected to $V_{IN}$ through an external 20k resistor without damage)                                                   | $V_{ENABLE}$ | -0.3 to 16           | V        |
| Output Voltage                                                                                                                                            | $V_{OUT}$    | -0.3 to +7.0         | V        |
| RESET Voltage                                                                                                                                             | $V_{RESET}$  | 0 V to $V_{OUT}$     | V        |
| RESET Current<br>(RESET may be incidentally shorted either to $V_{OUT}$ or to GND without damage)                                                         | $I_{RESET}$  | Internally Limited   | mA       |
| ESD Susceptibility (Human Body Model)                                                                                                                     | –            | 2.0                  | kV       |
| Logic Inputs/Outputs (Reset, WDI, Wake Up, Delay)                                                                                                         | –            | -0.3 to +7.0         | V        |
| Operating Junction Temperature                                                                                                                            | $T_J$        | -40 to 150           | °C       |
| Storage Temperature Range                                                                                                                                 | $T_S$        | -55 to +150          | °C       |
| Moisture Sensitivity Level<br>SOIC-16 EP (Case 751R)<br>SOIC-8 EP (Case 751AC)                                                                            | MSL          | 1<br>2               |          |
| Lead Temperature Soldering: Reflow<br>Leaded Part 60–150 sec above 183°C, 30 sec max at peak<br>Lead-Free Part 60–150 sec above 217°C, 40 sec max at peak | –<br>–       | 240 peak<br>265 peak | °C<br>°C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## THERMAL CHARACTERISTICS

| Parameter                                  | Board/Mounting Conditions Typical Value |                                    | Unit |
|--------------------------------------------|-----------------------------------------|------------------------------------|------|
| SO-8 Exposed Pad Package                   |                                         |                                    |      |
|                                            | 100 sq. mm spreader board (Note 1)      | 1 sq. inch spreader board (Note 2) |      |
| Junction to case top ( $\Psi_{JT}$ )       | 14                                      | 14                                 | °C/W |
| Junction to lead1 ( $\Psi_{JL1}$ )         | 36                                      | 26                                 | °C/W |
| Junction to board ( $\Psi_{JB}$ ) (Note 3) | 15                                      | 14                                 | °C/W |
| Junction to ambient ( $\theta_{JA}$ )      | 126                                     | 80                                 | °C/W |
| SO-16 Exposed Pad Package                  |                                         |                                    |      |
|                                            | 100 sq. mm spreader board (Note 1)      | 1 sq. inch spreader board (Note 2) |      |
| Junction to case top ( $\Psi_{JT}$ )       | 20                                      | 20                                 | °C/W |
| Junction to lead1 ( $\Psi_{JL1}$ )         | 41                                      | 26                                 | °C/W |
| Junction to board ( $\Psi_{JB}$ ) (Note 3) | 12                                      | 12                                 | °C/W |
| Junction to ambient ( $\theta_{JA}$ )      | 113                                     | 70                                 | °C/W |

**Specific notes on thermal characterization conditions:**

All boards are 0.062" thick FR4, 3" square, with varying amounts of copper heat spreader, in still air (free convection) conditions. Numerical values are derived from an axisymmetric finite-element model where active die area, total die area, flag area, pad area, and board area are equated to the actual corresponding areas.

- 1 oz copper, 100 mm<sup>2</sup> (0.155 in<sup>2</sup>) spreader area (includes exposed pad).
- 1 oz copper, 645 mm<sup>2</sup> (1 in<sup>2</sup>) spreader area (includes exposed pad).
- "board" is defined as center of exposed pad soldered to board; this is the recommended number to be used for thermal calculations, as it best represents the primary heat flow path and is least sensitive to board and ambient properties.

# NCV8518A

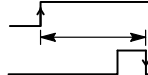
**ELECTRICAL CHARACTERISTICS** ( $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$ ;  $6.0\text{ V} \leq V_{\text{IN}} \leq 28\text{ V}$ ,  $100\text{ }\mu\text{A} \leq I_{\text{OUT}} \leq 150\text{ mA}$ ,  $C_2 = 1.0\text{ }\mu\text{F}$ ,  $R_{\text{Delay}} = 60\text{ k}$ ; unless otherwise specified.)

| Characteristic                                                                                                                                                                                                             | Symbol                     | Min        | Typ      | Max         | Unit               |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|------------|----------|-------------|--------------------|
| <b>Output</b>                                                                                                                                                                                                              |                            |            |          |             |                    |
| Output Voltage                                                                                                                                                                                                             | $V_{\text{OUT}}$           | 4.9<br>-2% | 5.00     | 5.10<br>+2% | V                  |
| Dropout Voltage ( $V_{\text{IN}} - V_{\text{OUT}}$ , $I_{\text{OUT}} = 150\text{ mA}$ ) (Note 4)                                                                                                                           | $V_{\text{DO}}$            | –          | 425      | 750         | mV                 |
| Load Regulation<br>( $V_{\text{IN}} = 13.5\text{ V}$ , $100\text{ }\mu\text{A} \leq I_{\text{OUT}} \leq 150\text{ mA}$ )                                                                                                   | $\text{Reg}_{\text{load}}$ | –          | 5.0      | 30          | mV                 |
| Line Regulation<br>( $6.0\text{ V} \leq V_{\text{IN}} \leq 28\text{ V}$ , $I_{\text{OUT}} = 5.0\text{ mA}$ )                                                                                                               | $\text{Reg}_{\text{line}}$ | –          | 5.0      | 20          | mV                 |
| Current Limit                                                                                                                                                                                                              | $I_{\text{lim}}$           | 255        | 400      | –           | mA                 |
| Thermal Shutdown (Guaranteed by Design)                                                                                                                                                                                    | $T_{\text{Jmax}}$          | 150        | 180      | 210         | $^{\circ}\text{C}$ |
| Quiescent Current<br>( $V_{\text{IN}} = 13.5\text{ V}$ , $I_{\text{OUT}} = 100\text{ }\mu\text{A}$ , $150\text{ mA}$ , $\text{ENABLE} = 2.0\text{ V}$ )<br>( $\text{ENABLE} = 0\text{ V}$ , $T_A = +125^{\circ}\text{C}$ ) | $I_{\text{Q}}$             | –<br>–     | 100<br>– | 150<br>1.0  | $\mu\text{A}$      |

## RESET

|                                                                                                                                                                                                                                                                                                                                                                  |                 |                        |                        |               |                  |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------------|------------------------|---------------|------------------|
| Threshold Voltage                                                                                                                                                                                                                                                               | –               | 4.50                   | 4.65                   | 4.75          | V                |
| Output Low<br>( $R_{\text{LOAD}} = 10\text{ k}$ to $V_{\text{OUT}}$ , $V_{\text{OUT}} = 1.0\text{ V}$ )                                                                                                                                                                                                                                                          | –               | –                      | 0.2                    | 0.4           | V                |
| Output High ( $R_{\text{LOAD}} = 10\text{ k}$ to GND)                                                                                                                                                                                                                                                                                                            | –               | $V_{\text{OUT}} - 0.4$ | $V_{\text{OUT}} - 0.2$ | –             | V                |
| Power On Reset Delay Time<br>( $V_{\text{IN}} = 13.5\text{ V}$ , $R_{\text{Delay}} = 60\text{ k}$ , $I_{\text{OUT}} = 5.0\text{ mA}$ )<br>( $V_{\text{IN}} = 13.5\text{ V}$ , $R_{\text{Delay}} = 120\text{ k}$ , $I_{\text{OUT}} = 5.0\text{ mA}$ )<br>$V_{\text{IN}} = 13.5\text{ V}$ , $R_{\text{Delay}} = 500\text{ k}$ , $I_{\text{OUT}} = 5.0\text{ mA}$ ) | $t_{\text{D}}$  | 2.0<br>–<br>–          | 3.0<br>6.0<br>25       | 4.0<br>–<br>– | ms               |
| Reset Reaction Time                                                                                                                                                                                                                                                                                                                                              | $T_{\text{rr}}$ | –                      | 20                     | –             | $\mu\text{s}$    |
| Input and ENABLE Transient Rejection (Note 6)                                                                                                                                                                                                                                                                                                                    | $dV/dt$         | 1.0                    | –                      | –             | V/ $\mu\text{s}$ |

## Watchdog Input

|                                                                                                                                                     |                            |     |     |     |                    |
|-----------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|-----|-----|-----|--------------------|
| Threshold                                                                                                                                           | $\text{WDI}_{\text{high}}$ | 30  | 50  | 70  | % $V_{\text{OUT}}$ |
| Hysteresis                                                       | $\text{WDI}_{\text{hys}}$  | 25  | 100 | –   | mV                 |
| Input Current ( $\text{WDI} = 6.0\text{ V}$ )                                                                                                       | –                          | –   | 0.1 | 2.0 | $\mu\text{A}$      |
| Wake Up Rising Edge to WDI Falling Edge Delay<br>Wake Up <br>WDI | –                          | 5.0 | –   | –   | $\mu\text{s}$      |

## ENABLE (Note 5)

|                                                  |                     |          |        |          |               |
|--------------------------------------------------|---------------------|----------|--------|----------|---------------|
| Input Threshold<br>Logic Low<br>Logic High       | $V_{\text{th(EN)}}$ | –<br>2.0 | –<br>– | 0.8<br>– | V             |
| Input Current ( $\text{ENABLE} = 2.0\text{ V}$ ) | –                   | –        | 3.0    | 10       | $\mu\text{A}$ |

4. Measured when the output voltage has dropped 2% from the nominal value.
5. If ENABLE is connected to  $V_{\text{IN}}$ , a  $20\text{ k}\Omega$  resistor must be placed in series.
6. Slew rates in excess of this limit may cause RESET to change state.

## NCV8518A

**ELECTRICAL CHARACTERISTICS (continued)** ( $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$ ;  $6.0\text{ V} \leq V_{\text{IN}} \leq 28\text{ V}$ ,  $100\text{ }\mu\text{A} \leq I_{\text{OUT}} \leq 150\text{ mA}$ ,  $C_2 = 1.0\text{ }\mu\text{F}$ ,  $R_{\text{Delay}} = 60\text{ k}$ ; unless otherwise specified.)

| Characteristic                                                                                                                                                                                              | Symbol | Min                    | Typ                     | Max          | Unit          |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|------------------------|-------------------------|--------------|---------------|
| <b>Wake Up Output</b> ( $V_{\text{IN}} = 14\text{ V}$ , $I_{\text{OUT}} = 5.0\text{ mA}$ )                                                                                                                  |        |                        |                         |              |               |
| Wake Up Period<br>( $R_{\text{DELAY}} = 60\text{ k}$ )<br>( $R_{\text{DELAY}} = 120\text{ k}$ )<br>( $R_{\text{DELAY}} = 500\text{ k}$ )                                                                    | –      | 18<br>–<br>–           | 25<br>50<br>208         | 32<br>–<br>– | ms            |
| Wake Up Duty Cycle Nominal                                                                                                                                                                                  | –      | 45                     | 50                      | 55           | %             |
| RESET HIGH to Wake Up Rising Delay Time<br>( $R_{\text{DELAY}} = 60\text{ k}$ ) 50% RESET Rising Edge to<br>50% Wake Up Edge ( $R_{\text{DELAY}} = 120\text{ k}$ )<br>( $R_{\text{DELAY}} = 500\text{ k}$ ) | –      | 9.0<br>–<br>–          | 12.5<br>25<br>104       | 16<br>–<br>– | ms            |
| Wake Up Response to Watchdog Input<br>50% WDI Falling Edge to<br>50% Wake Up Falling Edge                                                                                                                   | –      | –                      | 0.1                     | 5.0          | $\mu\text{s}$ |
| Wake Up Response to RESET<br>50% RESET Falling Edge to<br>50% Wake Up Falling Edge<br>( $V_{\text{OUT}} = 5.0\text{ V} \rightarrow 4.5\text{ V}$ )                                                          | –      | –                      | 0.1                     | 5.0          | $\mu\text{s}$ |
| Output Low ( $R_{\text{LOAD}} = 10\text{ k}$ )                                                                                                                                                              | –      | –                      | 0.2                     | 0.4          | V             |
| Output High ( $R_{\text{LOAD}} = 10\text{ k}$ )                                                                                                                                                             | –      | $V_{\text{OUT}} - 0.5$ | $V_{\text{OUT}} - 0.25$ | –            | V             |
| <b>Delay</b>                                                                                                                                                                                                |        |                        |                         |              |               |
| Output Voltage ( $R_{\text{DELAY}} = 60\text{ k}, 120\text{ k}, 500\text{ k}$ )                                                                                                                             | –      | –                      | 0.48                    | –            | V             |

## DEFINITION OF TERMS

**Dropout Voltage:** The input-to-output voltage differential at which the circuit ceases to regulate against further reduction in input voltage. Measured when the output voltage has dropped 100 mV from the nominal value obtained at 14 V input, dropout voltage is dependent upon load current and junction temperature.

**Input Voltage:** The DC voltage applied to the input terminals with respect to ground.

**Line Regulation:** The change in output voltage for a change in the input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that the average chip temperature is not significantly affected.

**Load Regulation:** The change in output voltage for a change in load current at constant chip temperature.

**Quiescent Current:** The part of the positive input current that does not contribute to the positive load current. The regulator ground lead current with no load.

**Current Limit:** Peak current that can be delivered to the output.

TIMING DIAGRAMS

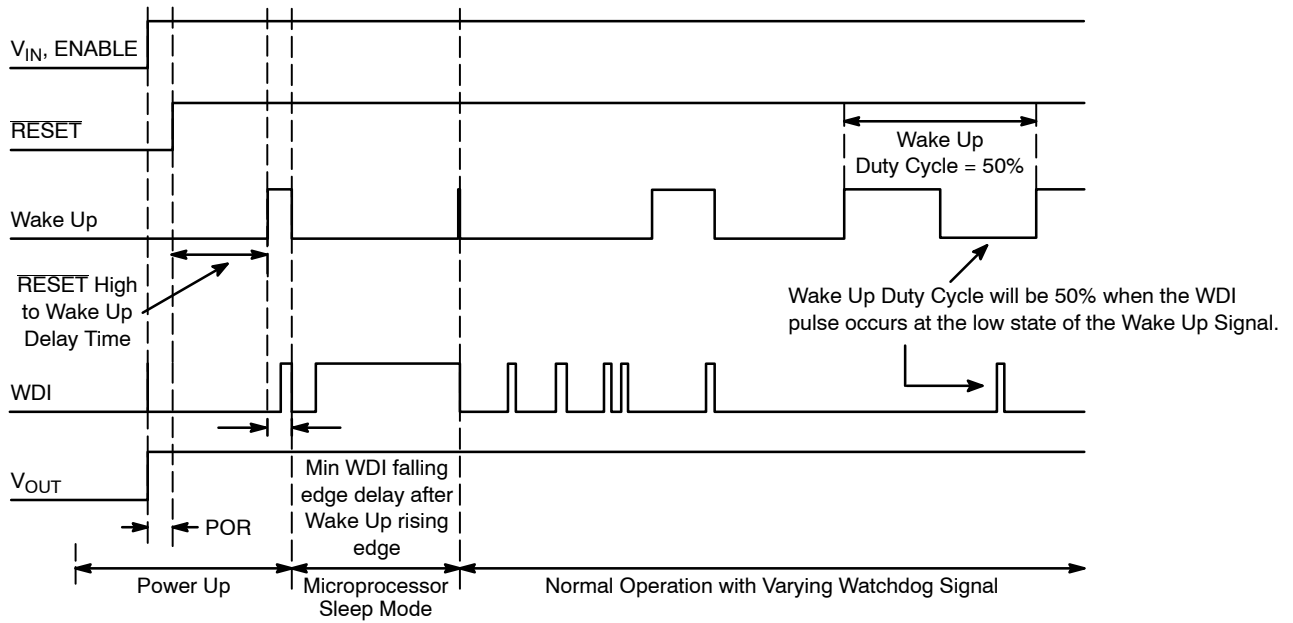


Figure 2. Power Up, Sleep Mode and Normal Operation

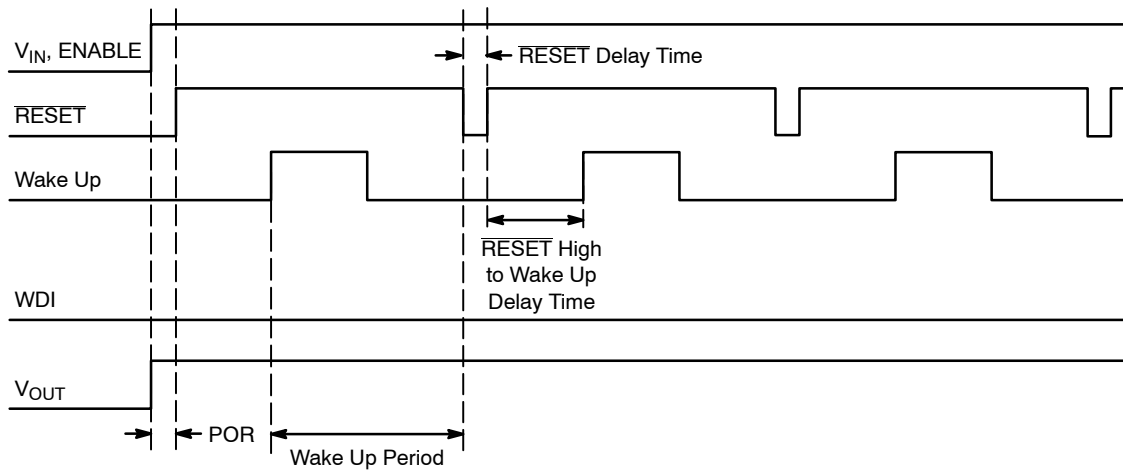


Figure 3. Error Condition: Watchdog Remains Low and a  $\overline{\text{RESET}}$  is Issued

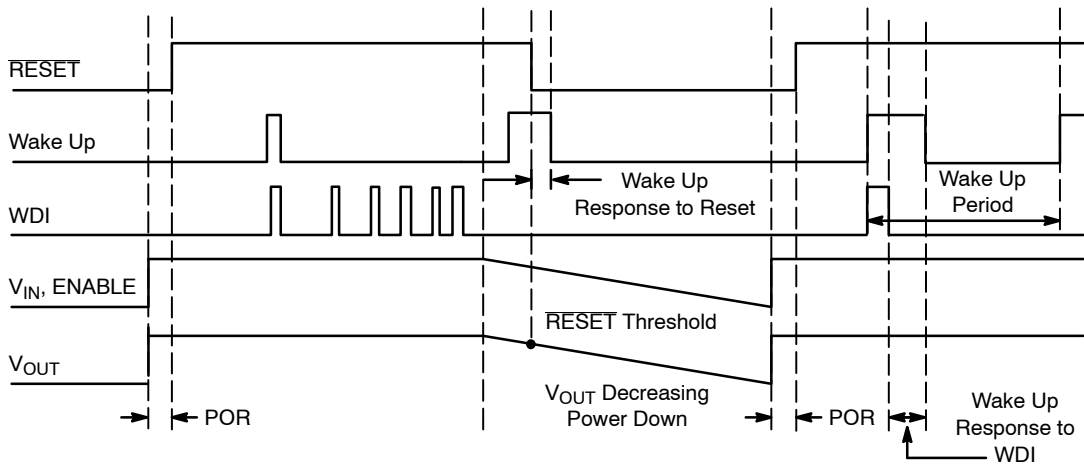


Figure 4. Power Down, Restart Sequence, and Wake Up Response to WDI

TYPICAL PERFORMANCE CHARACTERISTICS

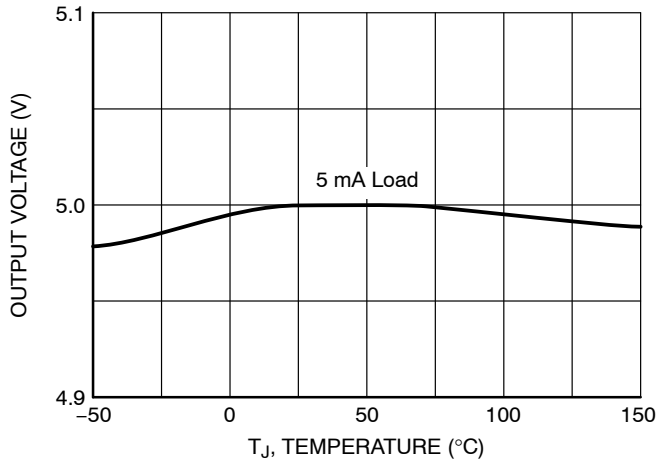


Figure 5. Output Voltage vs. Temperature

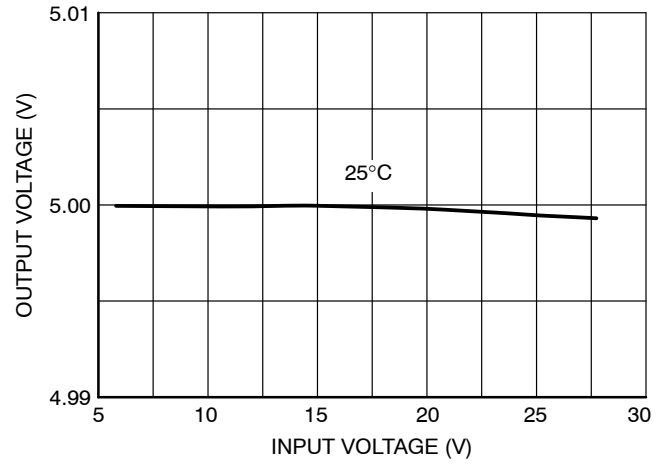


Figure 6. Output Voltage vs. Input Voltage

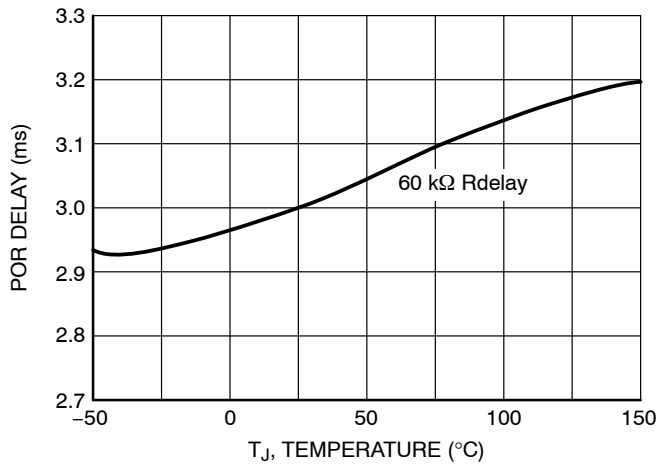


Figure 7. POR Delay vs. Temperature, 60 kΩ Rdelay

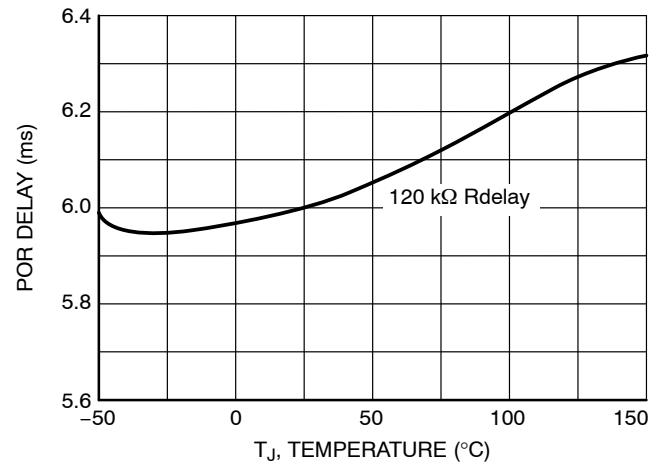


Figure 8. POR Delay vs. Temperature, 120 kΩ Rdelay

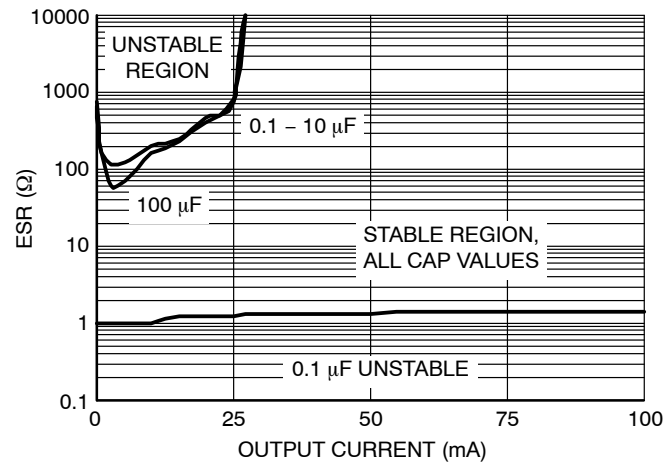


Figure 9. Stability Region of Capacitive ESR vs. Output Current

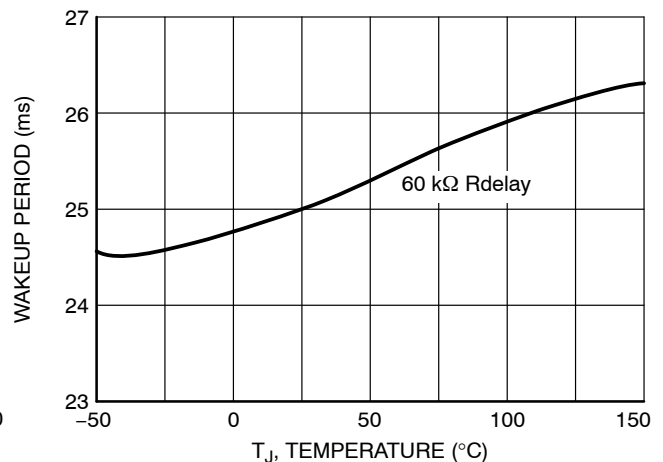


Figure 10. Wakeup Period vs. Temperature

TYPICAL PERFORMANCE CHARACTERISTICS

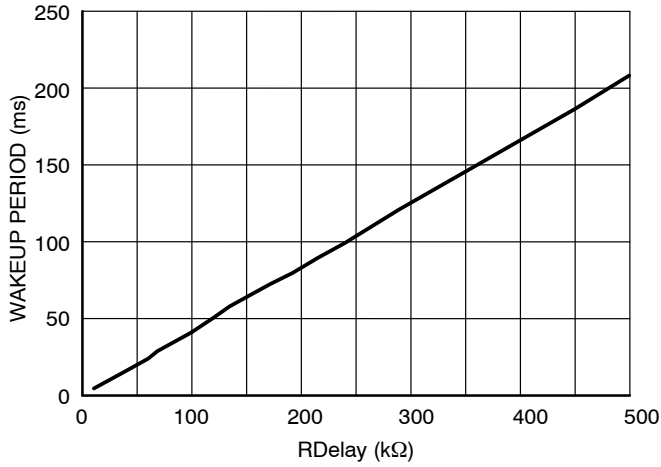


Figure 11. Wakeup Period vs. RDelay

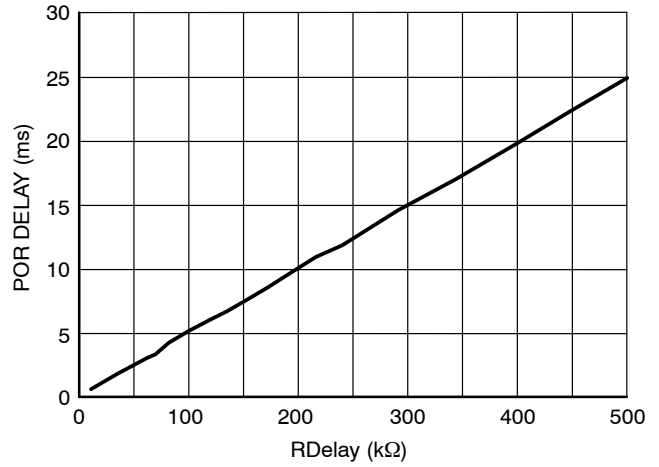


Figure 12. POR Delay vs. RDelay

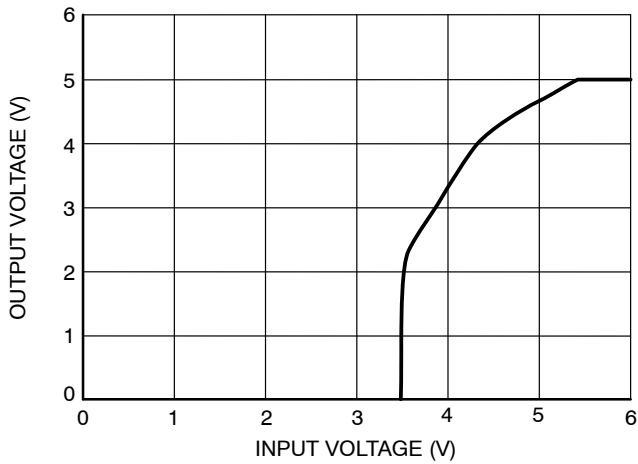


Figure 13. Output Voltage vs. Input Voltage, 5 mA Load

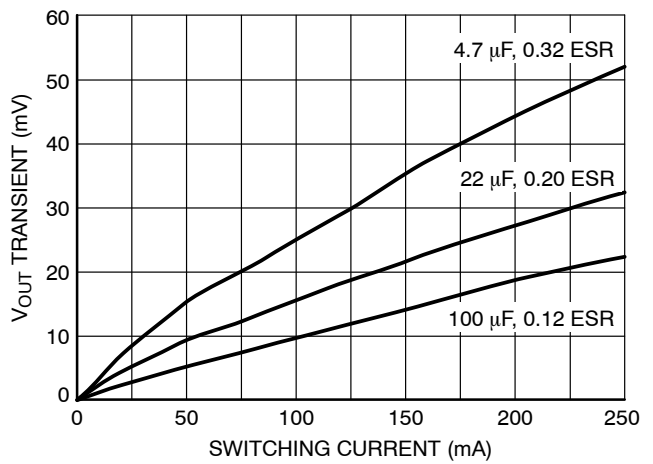


Figure 14. Load Transient Response

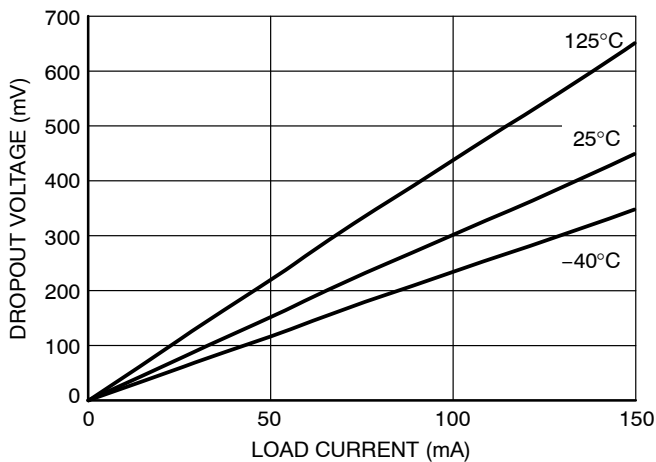


Figure 15. Dropout Voltage vs. Output Current

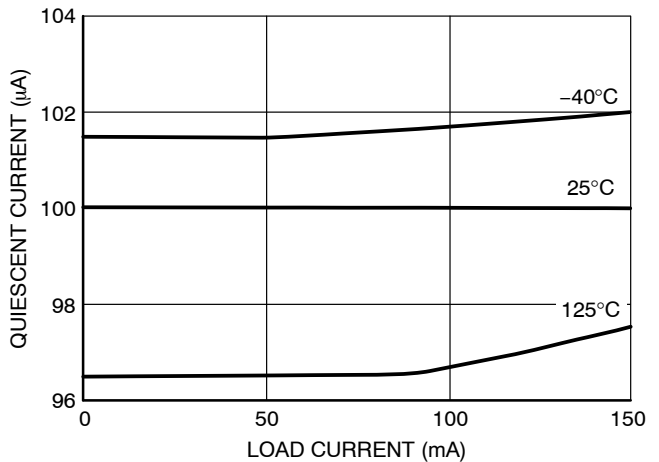


Figure 16. Quiescent Current vs. Output Current

## OPERATING DESCRIPTION

**General**

The NCV8518A is a precision micropower voltage regulator featuring low quiescent current (100  $\mu$ A typical at 250 mA load) and low dropout voltage (450 mV typical at 150 mA). Integrated microprocessor control functions include Watchdog, Wakeup and  $\overline{\text{RESET}}$ . An Enable input is provided for logic level control of the regulator state. The combination of low quiescent current and comprehensive microprocessor interface functions make the NCV8518A ideal for use in both battery operated and automotive applications.

The NCV8518A is internally protected against short circuit and thermal runaway conditions. No external components are required to engage these protective mechanisms. The device continues to operate through 45 volt input transients, an important consideration in automotive environments.

**Wakeup and Watchdog**

To reduce battery drain, a microprocessor or microcontroller can transition to a low current consumption ("sleep") mode when code execution is suspended or complete. The NCV8518A Wakeup signal is generated and output periodically to interrupt sleep mode. The nominal Wakeup output is a 5 volt square wave (generated from  $V_{\text{OUT}}$ ) with a duty cycle of 50%, at a frequency determined by external timing resistor  $R_{\text{DELAY}}$ . In response to the rising edge of the Wakeup signal, the microprocessor will subsequently output a Watchdog pulse and check its inputs to decide if it should resume normal operation or remain in sleep mode.

The NCV8518A responds to the falling edge of the Watchdog signal, which it expects at least once during each Wakeup period. When the correct Watchdog signal is received, the Wakeup output is forced low. Other Watchdog pulses received within the same cycle are ignored. The Watchdog circuitry continuously monitors the input Watchdog signal (WDI) from the microprocessor. The absence of a falling edge on the Watchdog input during one Wakeup cycle will cause a Reset pulse to be output at the end of the Wakeup cycle (see Figure 4).

**RESET**

As output voltage falls, the  $\overline{\text{RESET}}$  output will maintain its current state down to  $V_{\text{OUT}} = 1$  V. A Reset signal (active low) is asserted for any of four conditions:

1. During power up,  $\overline{\text{RESET}}$  is held low until the output voltage is in regulation.
2. During operation, if the output voltage falls below the Reset threshold,  $\overline{\text{RESET}}$  switches low, and will remain low until both the output voltage has recovered and the Reset delay timer cycle has completed following that recovery.
3.  $\overline{\text{RESET}}$  will switch low if the regulator does not receive a Watchdog input signal within a Wakeup period.
4. Regardless of output voltage,  $\overline{\text{RESET}}$  will switch low if the regulator input voltage  $V_{\text{IN}}$ , falls below a level required to sustain the internal control circuits. The specific voltage is temperature dependent, and is approximately 4.75 V at 20°C.

The Wakeup output is pulled low during a  $\overline{\text{RESET}}$  regardless of the cause of the  $\overline{\text{RESET}}$ . After the  $\overline{\text{RESET}}$  returns high, the Wakeup cycle begins again (see Figure 4).

The  $\overline{\text{RESET}}$  Delay Time, Wakeup signal frequency and  $\overline{\text{RESET}}$  high to Wakeup delay time are all set by one external resistor,  $R_{\text{Delay}}$ , according to the following equations:

$$\text{Wakeup Period (seconds)} = (4.17 \times 10^{-7}) * R_{\text{DELAY}} (\Omega)$$

$$\overline{\text{RESET}} \text{ Delay Time (seconds)} = (5.21 \times 10^{-8}) * R_{\text{DELAY}} (\Omega)$$

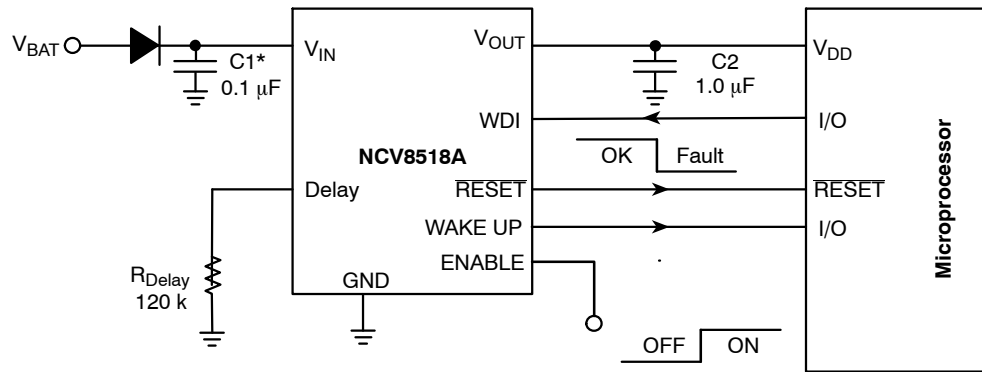
$$\overline{\text{RESET}} \text{ High to Wakeup Delay Time (seconds)} = (2.08 \times 10^{-7}) * R_{\text{DELAY}} (\Omega)$$

The voltage present at the Delay pin is a buffered bandgap voltage (~1.25 V) and can be used as a reference for an external tracking regulator.

**Enable**

This is a standard TTL and CMOS logic compatible input that can be used to turn the regulator on or off. Logic high enables the regulator; logic low disables it (also called *shutdown*). In the disabled/shutdown state, the pass transistor is off and total quiescent current is less than 1  $\mu$ A.

## NCV8518A



\*C1 required if regulator is located far from power supply filter.

**Figure 17. Application Circuit**

# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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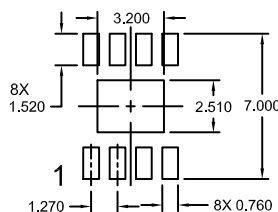
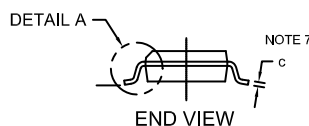
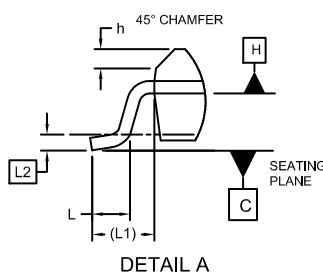
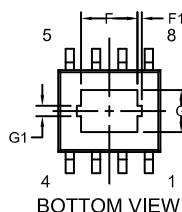
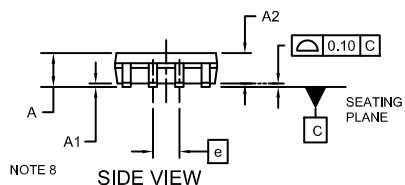
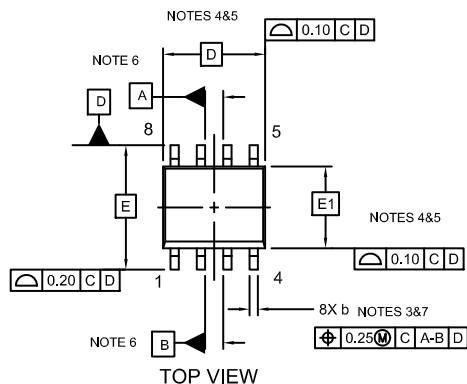
SCALE 1:1

## SOIC-8 EP CASE 751AC ISSUE D

DATE 02 APR 2019

### NOTES:

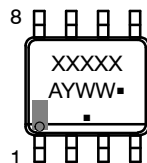
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.004 IN EXCESS OF MAXIMUM MATERIAL CONDITION.
4. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 PER SIDE. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.010 mm PER SIDE.
5. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
6. DATUMS A AND B ARE TO BE DETERMINED AT DATUM H.
7. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 FROM THE LEAD TIP.
8. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.



| DIM | MILLIMETERS |      |      |
|-----|-------------|------|------|
|     | MIN.        | NOM. | MAX. |
| A   | 1.35        | 1.55 | 1.75 |
| A1  | ---         | 0.05 | 0.10 |
| A2  | 1.35        | 1.50 | 1.65 |
| b   | 0.31        | 0.41 | 0.51 |
| c   | 0.17        | 0.21 | 0.23 |
| D   | 4.90 BSC    |      |      |
| E   | 6.00 BSC    |      |      |
| E1  | 3.90 BSC    |      |      |
| e   | 1.27 BSC    |      |      |
| F   | 2.24        | 2.72 | 3.20 |
| F1  | 0.15        | 0.20 | 0.25 |
| G   | 1.55        | 2.03 | 2.51 |
| G1  | 0.41        | 0.46 | 0.51 |
| h   | 0.25        | 0.38 | 0.50 |
| L   | 0.40        | 0.84 | 1.27 |
| L1  | 1.04 REF    |      |      |
| L2  | 0.25 REF    |      |      |
| Ø   | 0°          | 4°   | 8°   |

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D."

### GENERIC MARKING DIAGRAM\*



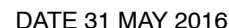
XXXXXX = Specific Device Code  
A = Assembly Location  
Y = Year  
WW = Work Week  
■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present and may be in either location. Some products may not follow the Generic Marking.

|                  |             |                                                                                                                                                                                     |
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- NOTES:**
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. 751R-01 OBSOLETE. NEW STANDARD 751R-02.

| DIM | MILLIMETERS |       | INCHES    |       |
|-----|-------------|-------|-----------|-------|
|     | MIN         | MAX   | MIN       | MAX   |
| A   | 10.15       | 10.45 | 0.400     | 0.411 |
| B   | 7.40        | 7.60  | 0.292     | 0.299 |
| C   | 2.35        | 2.65  | 0.093     | 0.104 |
| D   | 0.35        | 0.49  | 0.014     | 0.019 |
| F   | 0.50        | 0.90  | 0.020     | 0.035 |
| G   | 1.27 BSC    |       | 0.050 BSC |       |
| H   | 3.45        | 3.66  | 0.136     | 0.144 |
| J   | 0.25        | 0.32  | 0.010     | 0.012 |
| K   | 0.00        | 0.10  | 0.000     | 0.004 |
| L   | 4.72        | 4.93  | 0.186     | 0.194 |
| M   | 0 °         | 7 °   | 0 °       | 7 °   |
| P   | 10.05       | 10.55 | 0.395     | 0.415 |
| R   | 0.25        | 0.75  | 0.010     | 0.029 |

**BOTTOM VIEW**

The bottom view of the PCB layout shows a square pad with a central circular feature. The pad is labeled with the number 16. The central feature is labeled with the number 9. The pad is surrounded by a grid of 16 pins, with 8 pins on each side. The dimensions H and L are indicated. H is the horizontal distance from the center of the pad to the center of the pins. L is the vertical distance from the center of the pad to the center of the pins. A callout line points to the pad with the label EXPOSED PAD.

0.350

0.175

0.050

Exposed Pad

0.188

0.200

0.074

0.376

0.024

0.150

DIMENSIONS: INCHES

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

XXXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking.  
Pb-Free indicator, "G" or microdot "▪", may or may not be present.

|                         |                                |                                                                                                                                                                                     |
|-------------------------|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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